



# Product Change Notification

## 113136 - 00

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# Product Change Notification

**Change Notification #:** 113136 - 00  
**Change Title:** Intel® Server System R1304BTLSHBNR  
PCN 113136-00, Product Design  
Add a Mylar Bumper  
**Date of Publication:** July 15, 2014

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:*</b>	Jul 30, 2014
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*\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

## Description of Change to the Customer:

Intel is implementing the following change on the Intel® Server System R1304BTLSHBNR:

Add a mylar bumper on the side of the optical drive bay to improve the fit of the optical drive mechanical assembly. See the image below:



Figure 1. Example of the mylar bumper on the side of the optical drive bay

**Customer Impact of Change and Recommended Action:**

Intel anticipates no impact to customers. Customers may need to validate the function and feature change after receiving the system.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change TA	Post Change TA
R1304BTLSHBNR	920778	G65147-002	G65147-003

**PCN Revision History:****Date of Revision:**

July 15, 2014

**Revision Number:**

00

**Reason:**

Originally Published PCN